

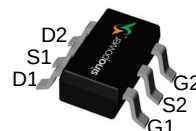
Features

- **N-Channel**
30V/4.9A,
 $R_{DS(ON)} = 39m\Omega(max.) @ V_{GS} = 10V$
 $R_{DS(ON)} = 68m\Omega(max.) @ V_{GS} = 4.5V$
- **P-Channel**
-30V/-3A,
 $R_{DS(ON)} = 100m\Omega(max.) @ V_{GS} = -10V$
 $R_{DS(ON)} = 170m\Omega(max.) @ V_{GS} = -4.5V$
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

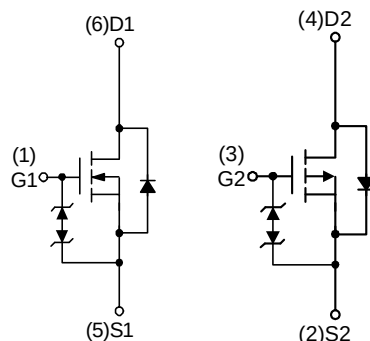
Applications

- Power Management in Notebook Computer, Portable Equipment and Battery Powered Systems.
- Load Switch

Pin Description



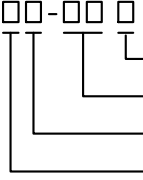
Top View of SOT-23-6



N-Channel

P-Channel

Ordering and Marking Information

SM2620CS □□-□□□  Assembly Material Handling Code Temperature Range Package Code	Package Code C : SOT-23-6 Operating Junction Temperature Range C : -55 to 150 °C Handling Code TR : Tape & Reel (3000ea/reel) Assembly Material G : Halogen and Lead Free Device
SM2620CS C : K20XX	XX - Lot Code

Note : SINOPOWER lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. SINOPOWER lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. SINOPOWER defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

SINOPOWER reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		N Channel	P Channel	Unit
Common Ratings					
V _{DSS}	Drain-Source Voltage		30	-30	V
V _{GSS}	Gate-Source Voltage		±20	±20	V
I _D	Continuous Drain Current	T _A =25°C	4.9	-3	A
		T _A =70°C	3.9	-2.4	
I _{DM}	300μs Pulsed Drain Current	V _{GS} =10V	19	-12	
I _S	Diode Continuous Forward Current		1		°C
T _J	Maximum Junction Temperature		150		
T _{STG}	Storage Temperature Range		-55 to 150		
P _D	Maximum Power Dissipation	T _A =25°C	1.4		W
		T _A =70°C	0.9		
R _{θJA} *	Thermal Resistance-Junction to Ambient	t ≤ 10s	90		°C/W
		Steady State	125		

Note: * Surface Mounted on 1in² pad area.

N Channel Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	N Channel			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V T _J =85°C	-	-	1 30	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	1.3	1.8	2.5	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±10	μA
R _{DS(ON)} ^a	Drain-Source On-State Resistance	V _{GS} =10V, I _{DS} =4.9A	-	32	39	mΩ
		V _{GS} =4.5V, I _{DS} =3A	-	52	68	
Diode Characteristics						
V _{SD} ^a	Diode Forward Voltage	I _{SD} =1A, V _{GS} =0V	-	0.75	1.1	V
t _{rr}	Reverse Recovery Time	I _{SD} =4.9A, dI _{SD} /dt=100A/μs	-	9.2	-	ns
Q _{rr}	Reverse Recovery Charge		-	4.3	-	nC
Dynamic Characteristics ^b						
R _g	Gate Resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	-	2.3	-	Ω
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, Frequency=1.0MHz	-	215	-	pF
C _{oss}	Output Capacitance		-	37	-	
C _{rss}	Reverse Transfer Capacitance		-	28	-	
t _{d(ON)}	Turn-on Delay Time	V _{DD} =15V, R _L =15Ω, I _{DS} =1A, V _{GEN} =10V, R _G =6Ω	-	5.3	8	ns
T _r	Turn-on Rise Time		-	11	16	
t _{d(OFF)}	Turn-off Delay Time		-	12	17	
T _f	Turn-off Fall Time		-	2.6	4	
Gate Charge Characteristics ^b						
Q _g	Total Gate Charge	V _{DS} =15V, I _{DS} =4.9A	V _{GS} =4.5V,	-	3	nC
			V _{GS} =10V	-	5.8	
Q _{gs}	Gate-Source Charge	V _{DS} =15V, V _{GS} =10V, I _{DS} =4.9A	-	1.1	-	
Q _{gd}	Gate-Drain Charge		-	1.5	-	
Q _{gth}	Threshold Gate Charge		-	0.5	-	

Note a: Pulse test; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

Note b: Guaranteed by design, not subject to production testing.

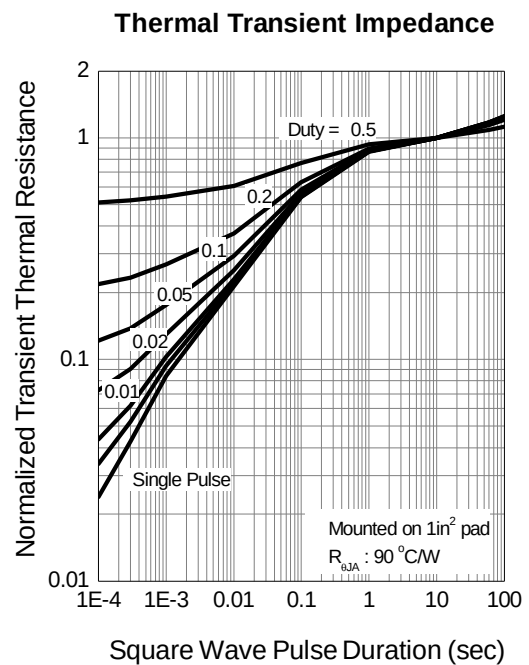
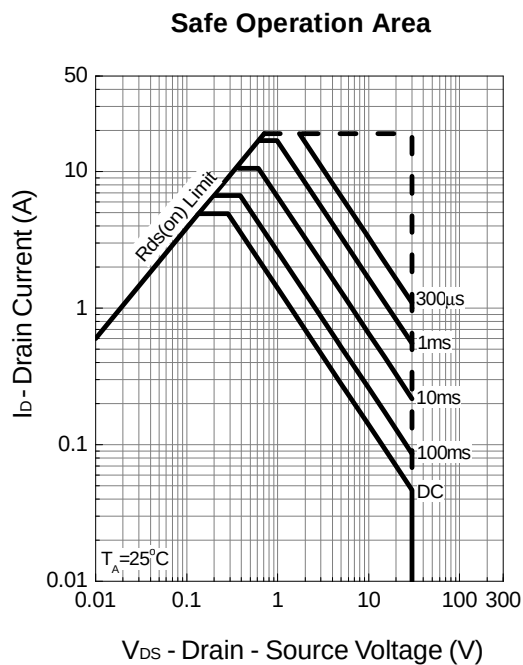
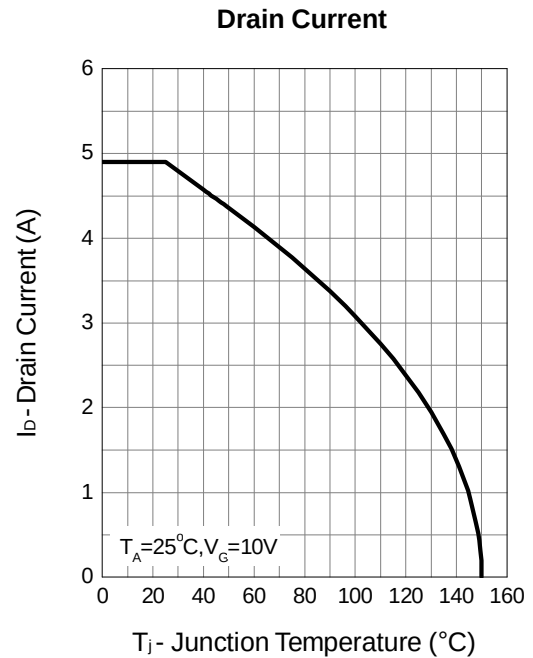
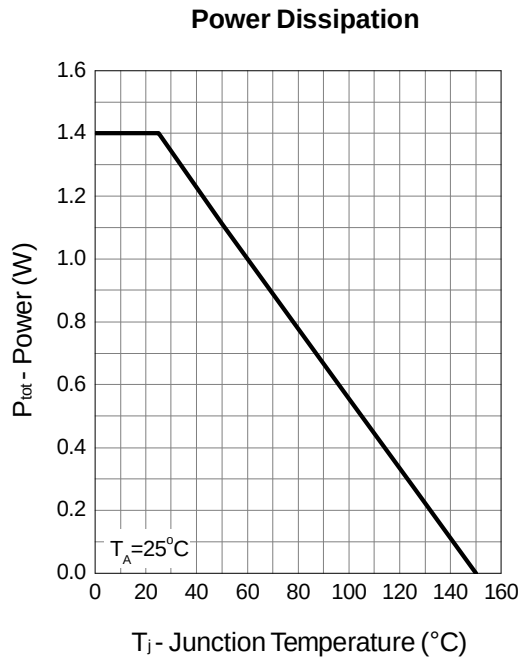
P Channel Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	P Channel			Unit	
			Min.	Typ.	Max.		
Static Characteristics							
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =-250μA	-30	-	-	V	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V	-	-	-1	μA	
		T _J =85°C	-	-	-30		
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =-250μA	-1.3	-1.8	-2.5	V	
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±10	μA	
R _{DS(ON)} ^a	Drain-Source On-State Resistance	V _{GS} =-10V, I _{DS} =-3A	-	82	100	mΩ	
		V _{GS} =-4.5V, I _{DS} =-1.9A	-	125	170		
Diode Characteristics							
V _{SD} ^a	Diode Forward Voltage	I _{SD} =-1A, V _{GS} =0V	-	-0.75	-1.1	V	
t _{rr}	Reverse Recovery Time	I _{SD} =-3A, dI _{SD} /dt=100A/μs	-	19	-	ns	
Q _{rr}	Reverse Recovery Charge		-	14	-	nC	
Dynamic Characteristics ^b							
R _g	Gate Resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	-	7	-	Ω	
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, Frequency=1.0MHz	-	229	-	pF	
C _{oss}	Output Capacitance		-	42	-		
C _{rss}	Reverse Transfer Capacitance		-	33	-		
t _{d(ON)}	Turn-on Delay Time	V _{DD} =-15V, R _L =15Ω, I _{DS} =-1A, V _{GEN} =-10V, R _G =6Ω	-	7.2	-	ns	
T _r	Turn-on Rise Time		-	9.3	-		
t _{d(OFF)}	Turn-off Delay Time		-	15.4	-		
T _f	Turn-off Fall Time		-	3.6	-		
Gate Charge Characteristics ^b							
Q _g	Total Gate Charge	V _{DS} =-15V, I _{DS} =-3A	V _{GS} =-4.5V,	-	3.3	-	nC
			V _{GS} =-10V	-	6.5	-	
Q _{gs}	Gate-Source Charge	V _{DS} =-15V, V _{GS} =-10V, I _{DS} =-3A	-	1.1	-		
Q _{gd}	Gate-Drain Charge		-	1.1	-		
Q _{gth}	Threshold Gate Charge		-	0.6	-		

Note a: Pulse test; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

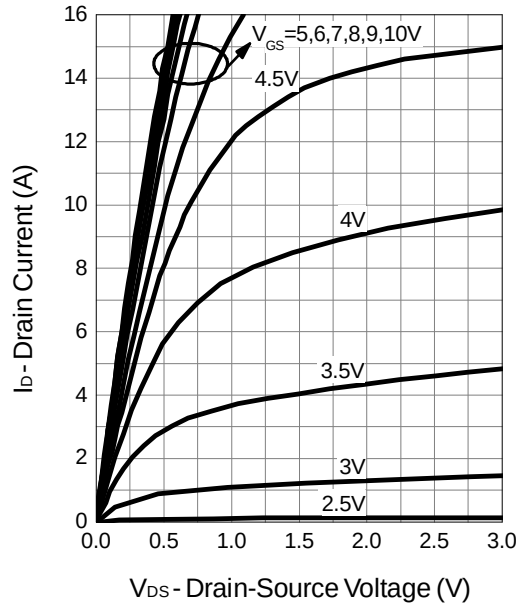
Note b: Guaranteed by design, not subject to production testing.

N Channel Typical Operating Characteristics

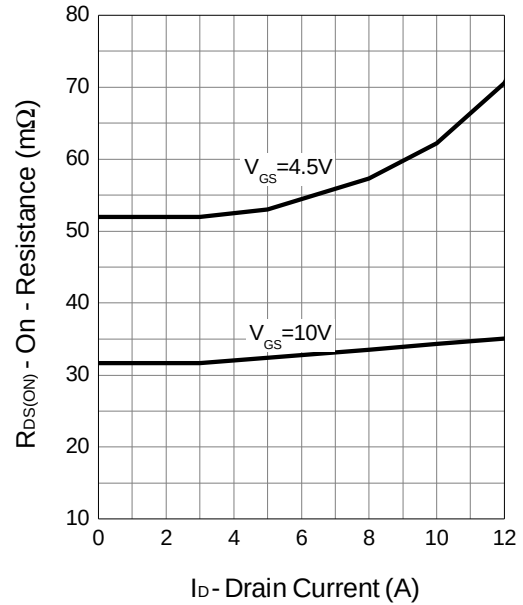


N Channel Typical Operating Characteristics (Cont.)

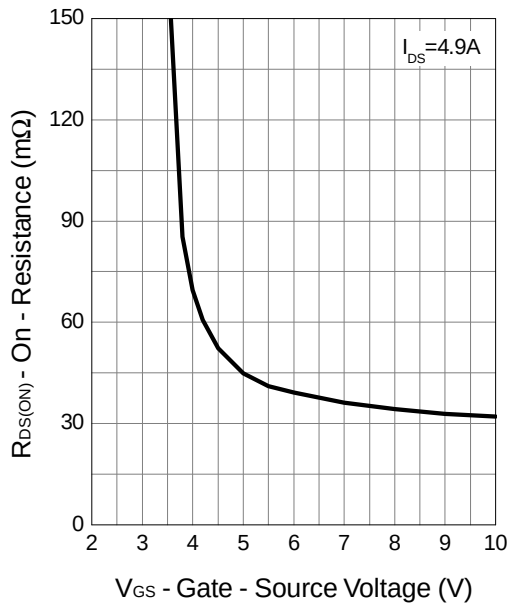
Output Characteristics



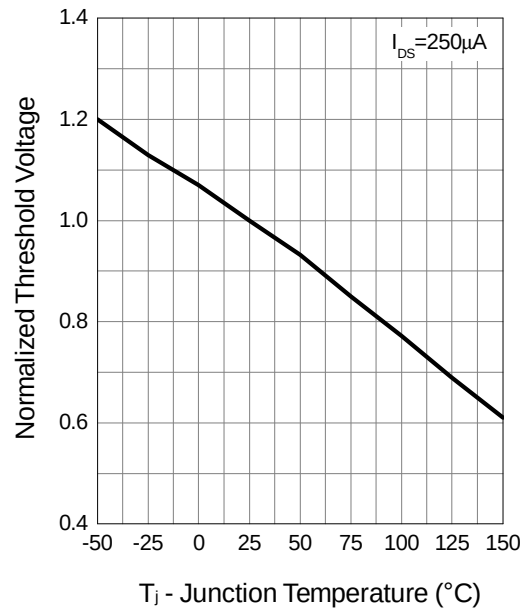
Drain-Source On Resistance



Gate-Source On Resistance

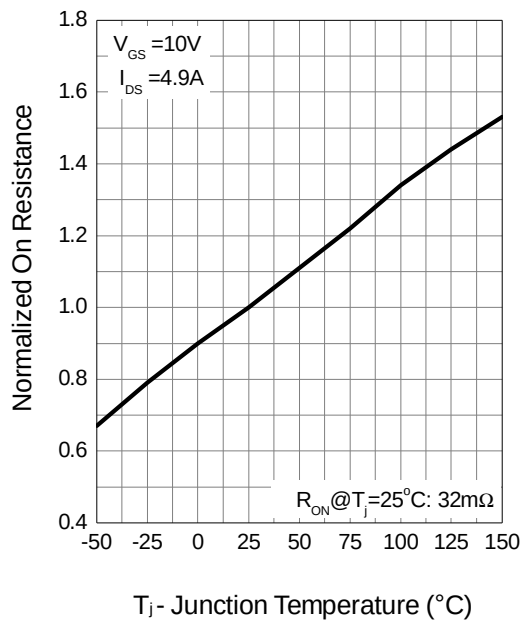


Gate Threshold Voltage

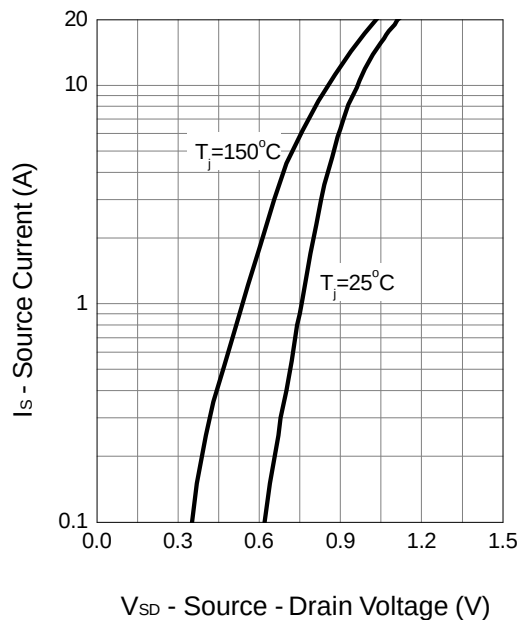


N Channel Typical Operating Characteristics (Cont.)

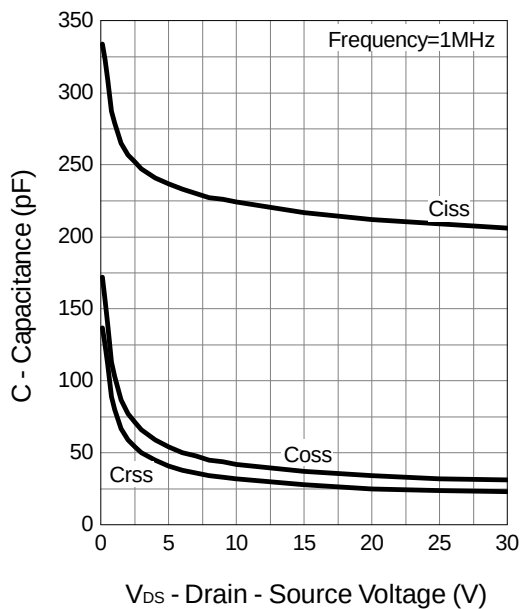
Drain-Source On Resistance



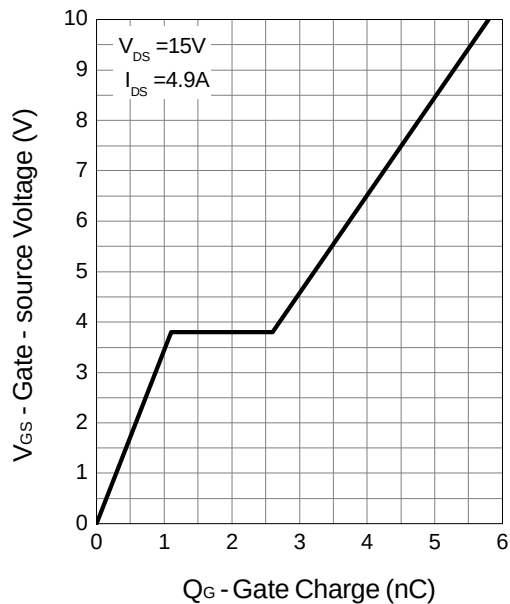
Source-Drain Diode Forward



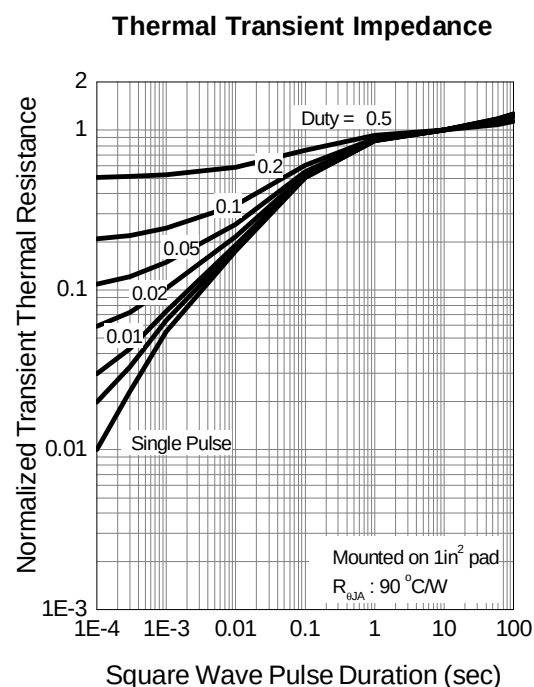
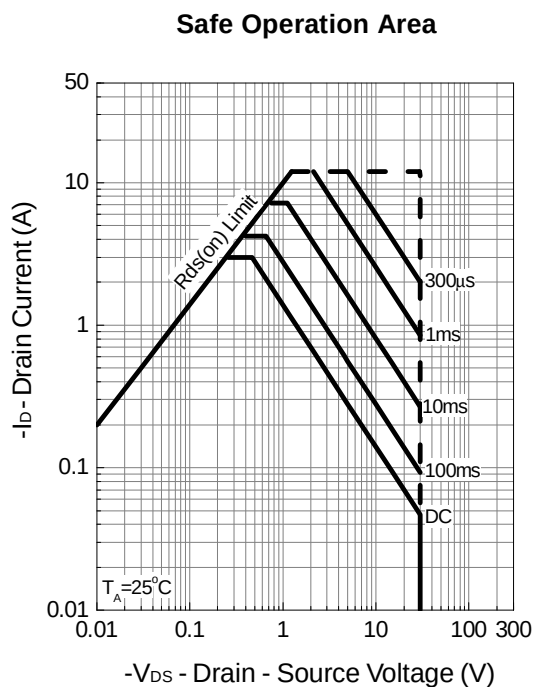
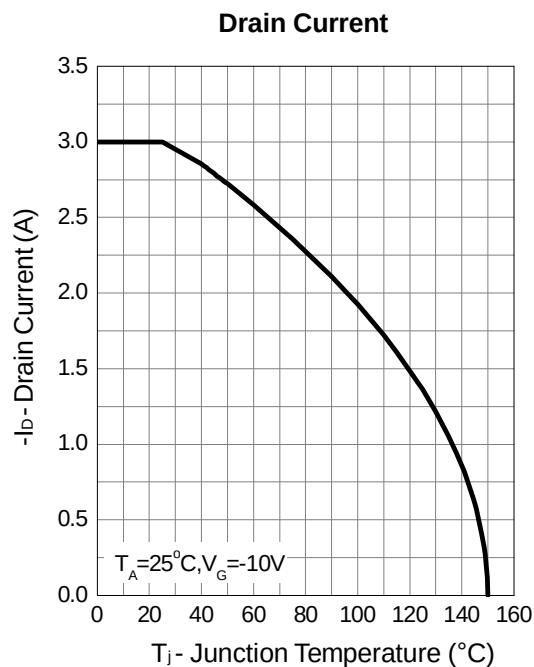
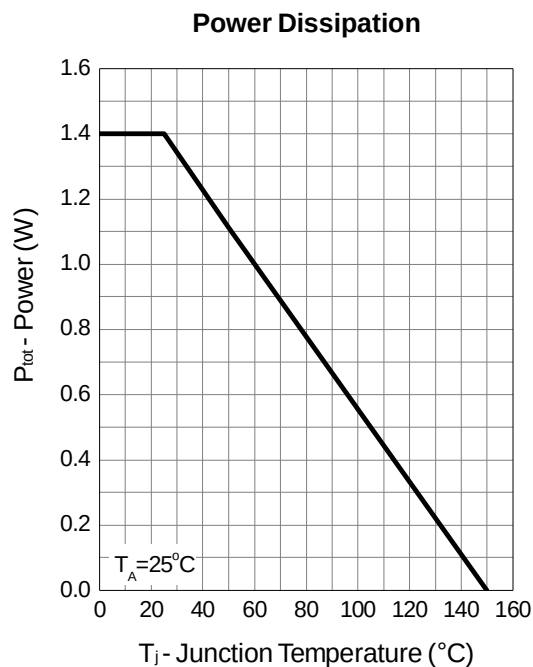
Capacitance



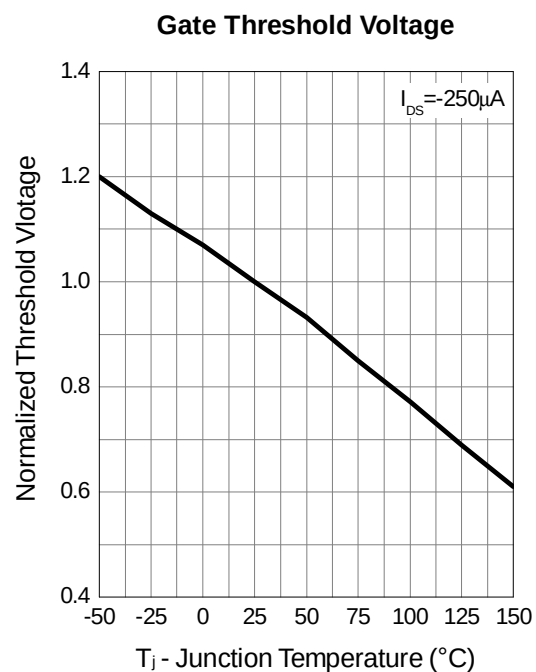
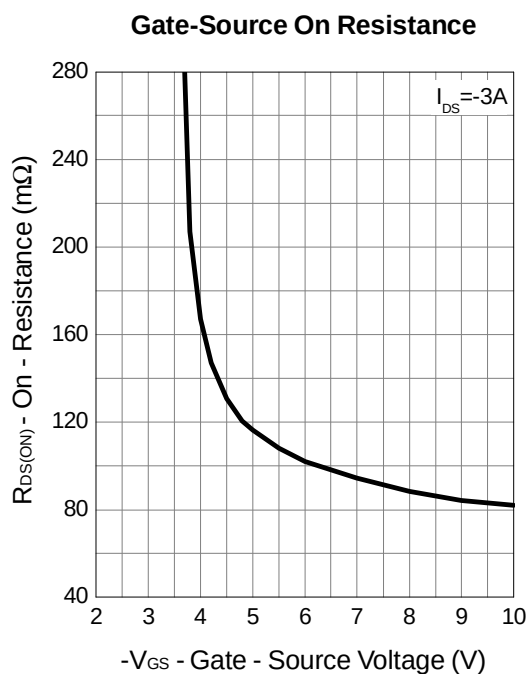
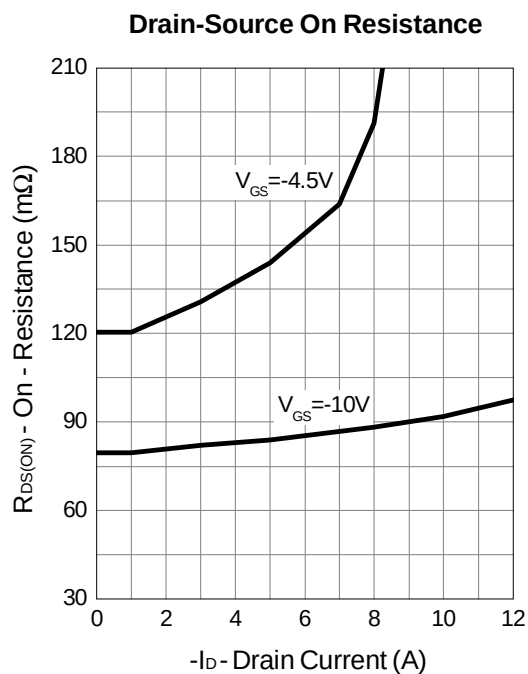
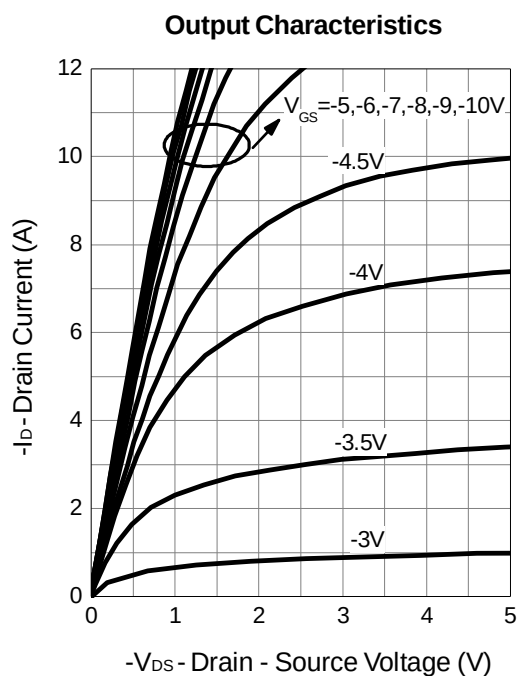
Gate Charge



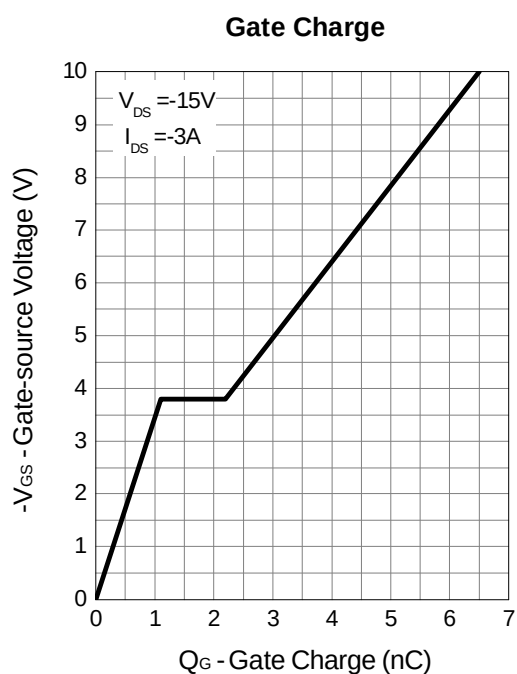
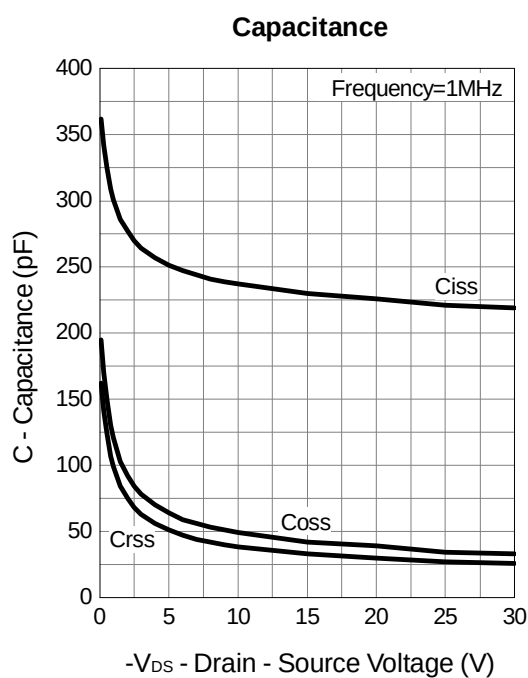
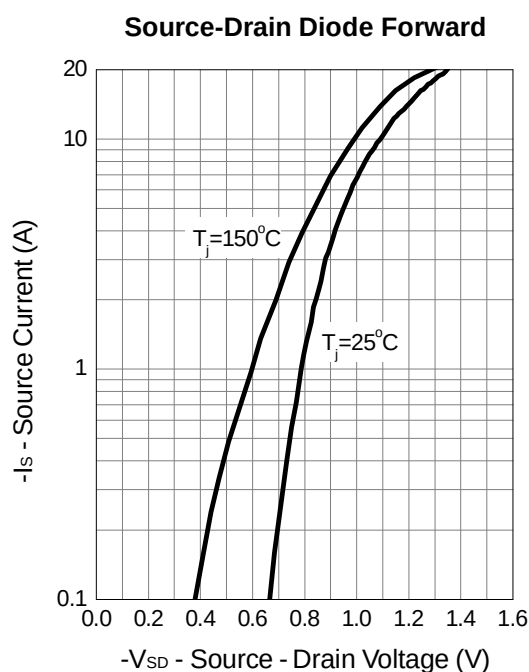
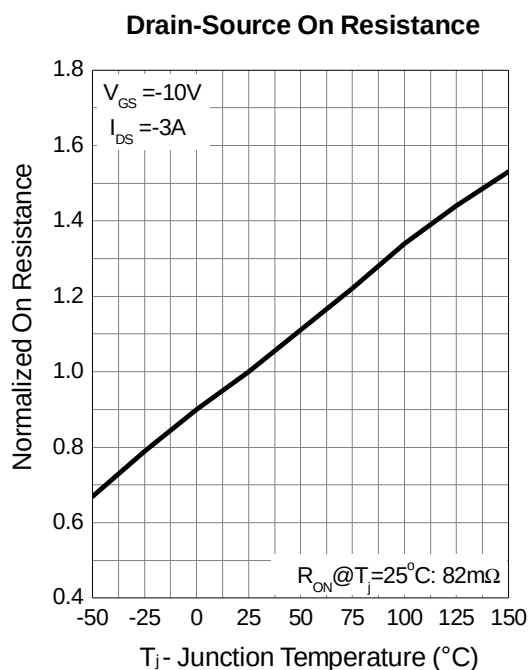
P Channel Typical Operating Characteristics



P Channel Typical Operating Characteristics (Cont.)

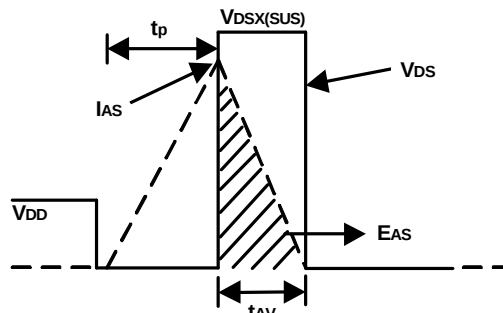
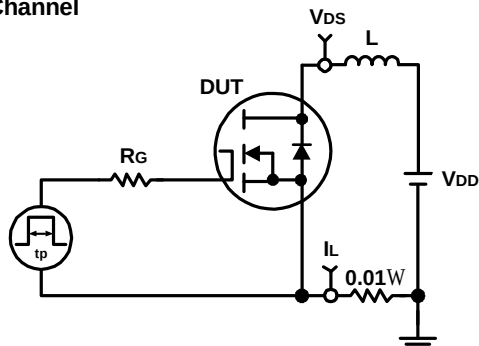


P Channel Typical Operating Characteristics (Cont.)

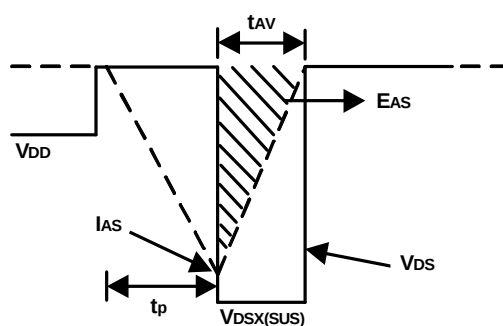
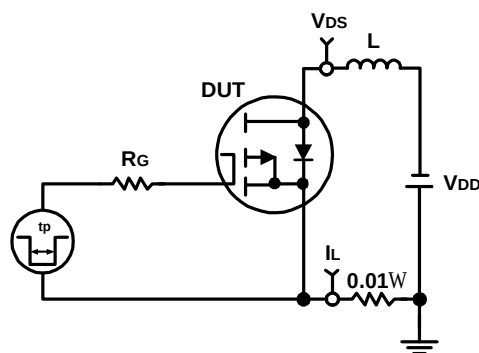


Avalanche Test Circuit and Waveforms

N Channel

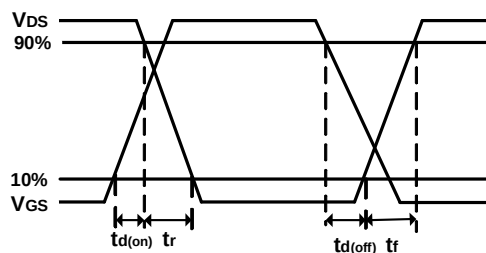
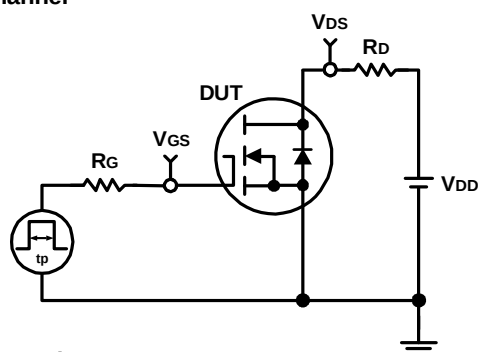


P Channel

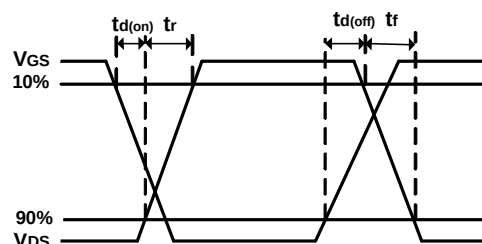
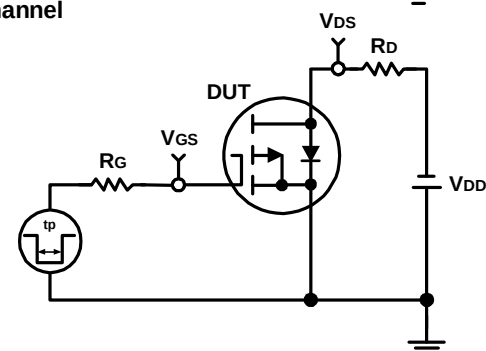


Switching Time Test Circuit and Waveforms

N Channel

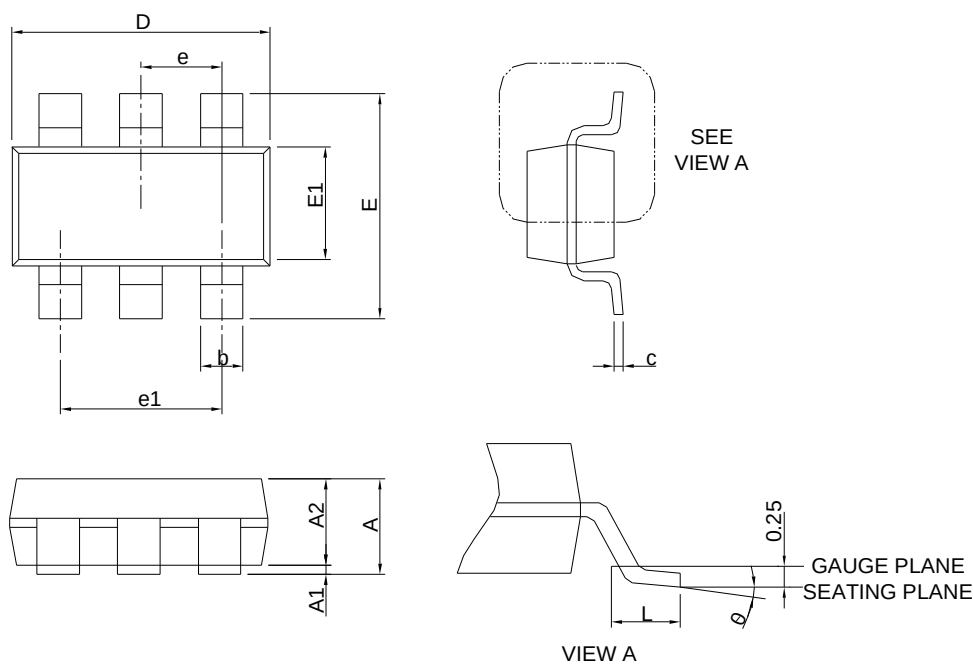


P Channel



Package Information

SOT-23-6

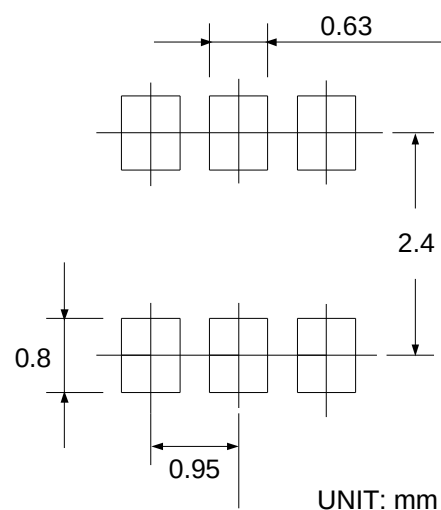


SYMBOL	SOT-23-6			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	-	1.25	-	0.049
A1	0.00	0.05	0.000	0.002
A2	0.90	1.20	0.035	0.047
b	0.30	0.50	0.012	0.020
c	0.08	0.22	0.003	0.009
D	2.70	3.10	0.106	0.122
E	2.60	3.00	0.102	0.118
E1	1.40	1.80	0.055	0.071
e	0.95 BSC		0.037 BSC	
e1	1.90 BSC		0.075 BSC	
L	0.30	0.60	0.012	0.024
θ	0°	8°	0°	8°

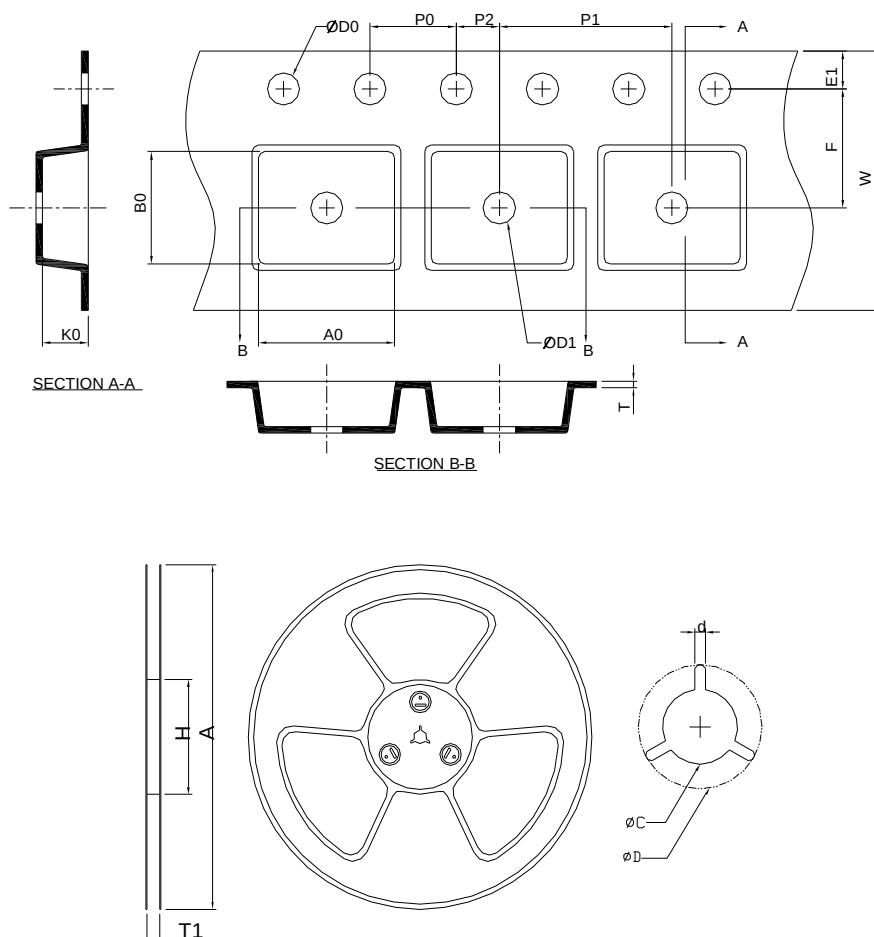
Note : 1. Follow JEDEC TO-178 AB.

2. Dimension D and E1 do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.

RECOMMENDED LAND PATTERN



Carrier Tape & Reel Dimensions



Application	A	H	T1	C	d	D	W	E1	F
SOT-23-6	178.0±2.00	50 MIN.	8.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	8.0±0.30	1.75±0.10	3.5±0.05
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.0±0.10	4.0±0.10	2.0±0.05	1.5+0.10 -0.00	1.0 MIN.	0.6+0.00 -0.40	3.20±0.20	3.10±0.20	1.50±0.20

(mm)

SOT-23-6

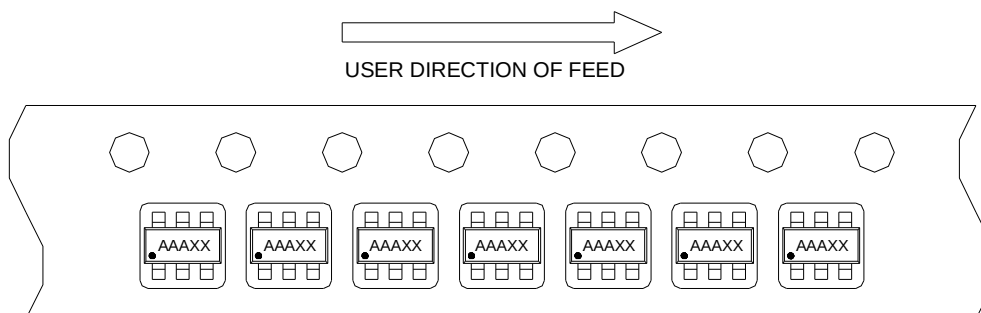


Figure 1 illustrates the temperature profile of a heat pump. The main graph plots Temperature (°C) against Time. The y-axis marks 25, T_L , T_p , and $T_c - 5^\circ\text{C}$. The x-axis marks t_s , t , and t_p . The curve starts at 25°C, rises through a "Preheat Area" between T_{smin} and T_{smax} , and peaks at T_p . A box specifies "Max. Ramp Up Rate = 3°C/s " and "Max. Ramp Down Rate = 6°C/s ". Two inset graphs show the heat pump's operating range: "Supplier $T_p \geq T_c$ " and "User $T_p \leq T_c$ ", both with a peak at $T_c - 5^\circ\text{C}$ and duration t_p .

Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak Temperature min (T_{smin}) Temperature max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max.	3°C/second max.
Liquidous temperature (T_L) Time at liquidous (t_L)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body Temperature (T_p)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t_p)** within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds
Average ramp-down rate (T_p to T_{smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	1000 Hrs, 80% of VDS max @ T_{jmax}
HTGB	JESD-22, A108	1000 Hrs, 100% of VGS max @ T_{jmax}
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C

Customer Service

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